

## D3CE60VE

# General Rectifying Diodes 600V, 3.5A

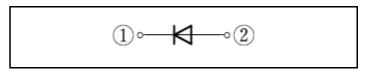
#### **Feature**

- Ultra-small SMD
- Ultra-thin PKG=1.0mm
- · Based on AEC-Q101
- · Pb free terminal
- RoHS:Yes

## **OUTLINE**

Package (House Name): CE
Package (JEITA Code): SC-110B

## **Equivalent circuit**



## Absolute Maximum Ratings (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperrature	Tstg		-55 to 150	°C
Junction temperature	Tj		-55 to 150	°C
Repetitive peak reverse voltage	$V_{RRM}$		600	V
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, TI=93°C	3.5	Α
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, TI=103°C	3	Α
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C *	1.2	А
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C *	0.8	А
Surge forward current	I <sub>FSM</sub>	50Hz sine wave, Non-repetitive 1 cycle peak value, Tj=25°C	60	Α
Surge forward current	I <sub>FSM1</sub>	tp=1ms, sine wave, Non-repetitive, peak value, Tj=25°C 120		Α

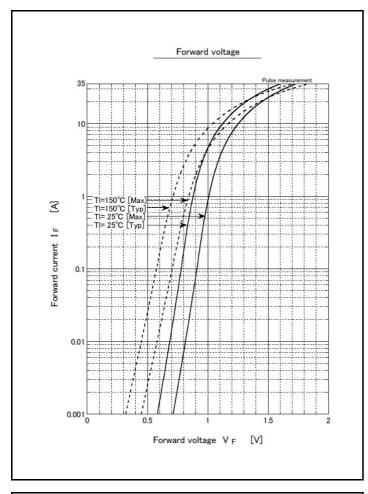
<sup>\* :</sup> See the original Specifications

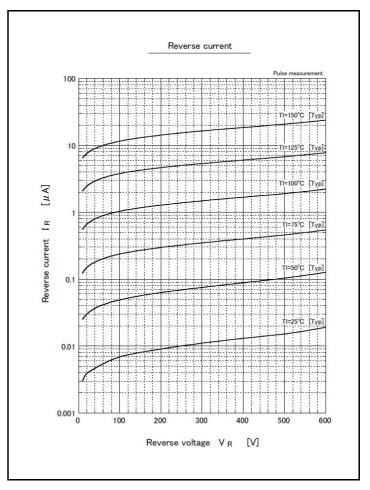
## **Electrical Characteristics** (unless otherwise specified : TI=25°C)

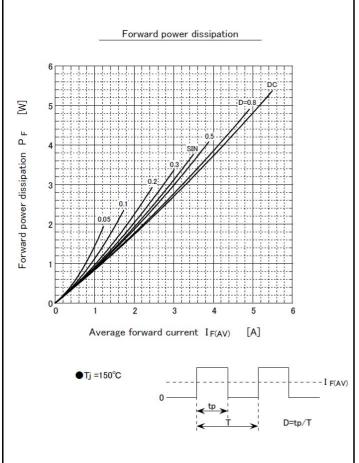
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	Oilit
Forward voltage	V <sub>F</sub>	IF=3.5A, Pulse measurement			1.1	V
Reverse current	I <sub>R</sub>	VR=600V, Pulse measurement			10	μΑ
Electro static dischange Capability	V <sub>ESD</sub>	C=330pF, R=330Ω, Polarity±, Aerial discharge		25		kV
Thermal resistance	Rth(j-l)	Junction to lead			15	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate *			115	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate *			172	°C/W

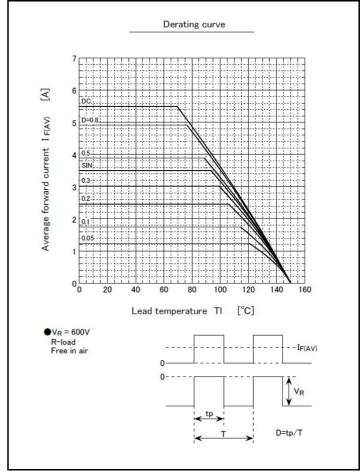
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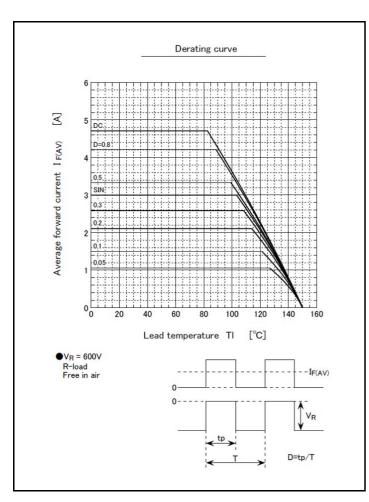
## **CHARACTERISTIC DIAGRAMS**

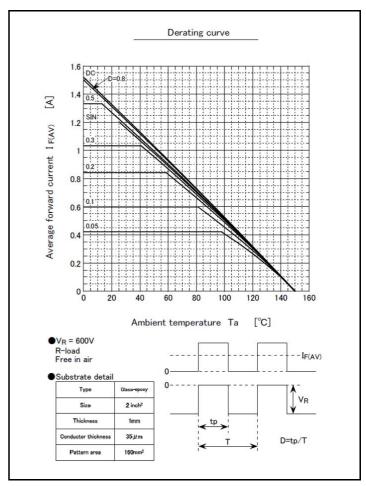


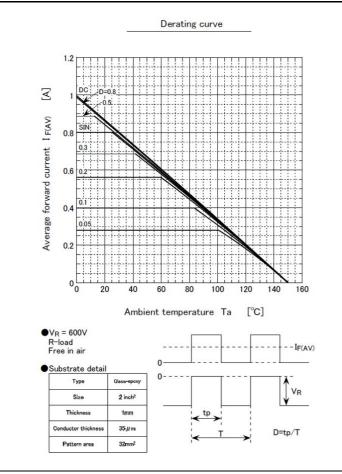


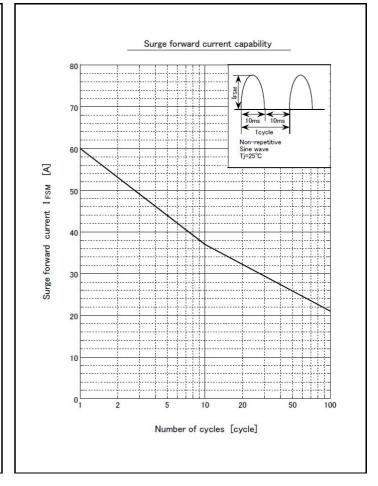


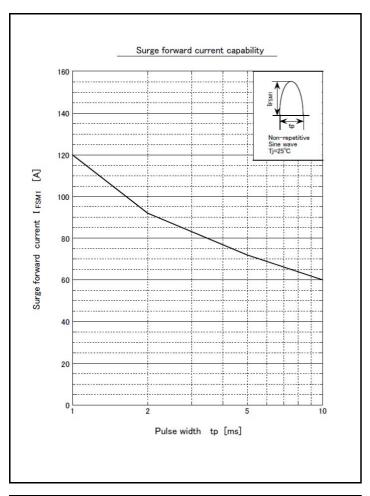


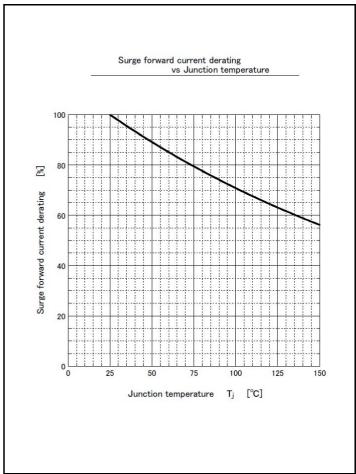


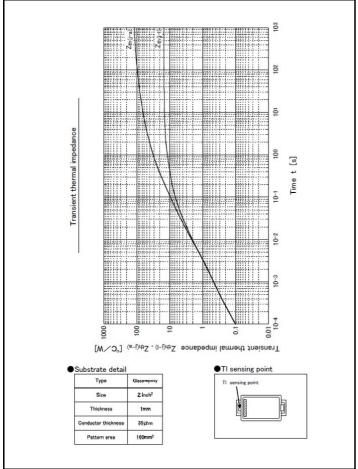


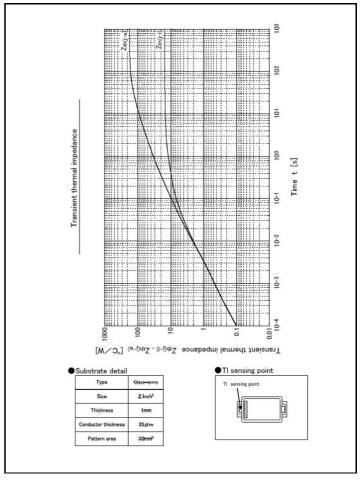








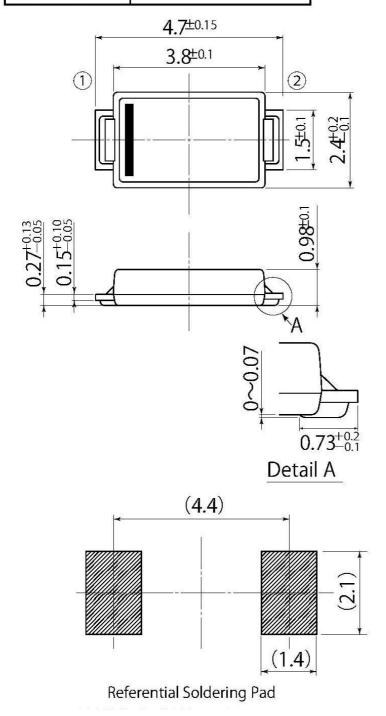


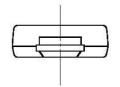


scale: 10/1

**B**5

JEDEC Code	()
JEITA Code	SC-110B
House Name	CE





<sup>•</sup> Optimize soldering pad to the board design and soldering condition.

#### **Notes**

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#### (Specific applications)

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